

Type-II Superlattice (T2SL) Barrier Infrared Detector (BIRD) for Earth Science Applications

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- Introduction
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- Summary

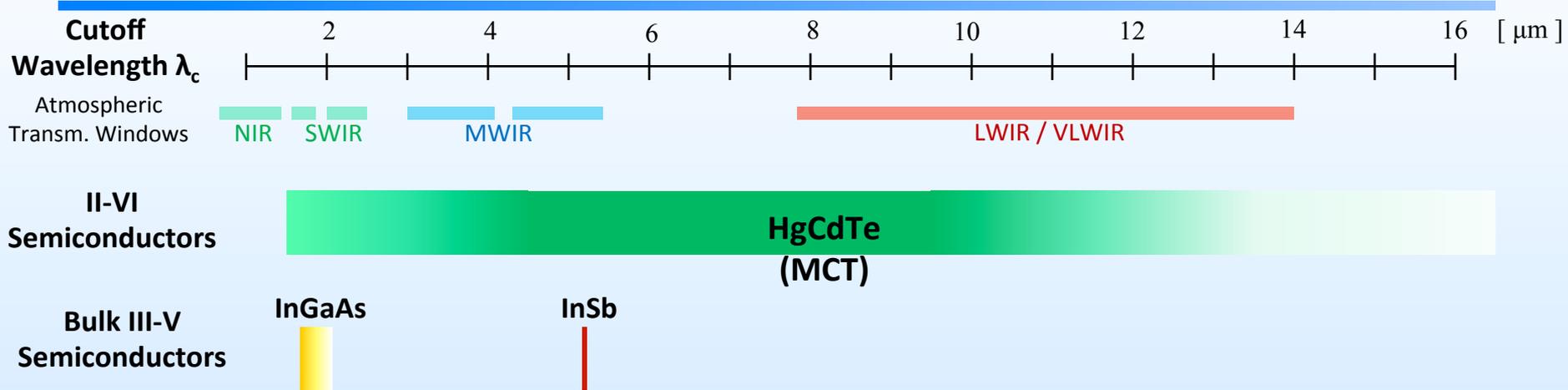


Introduction

Thermal Infrared Focal Plane Arrays for Earth Science

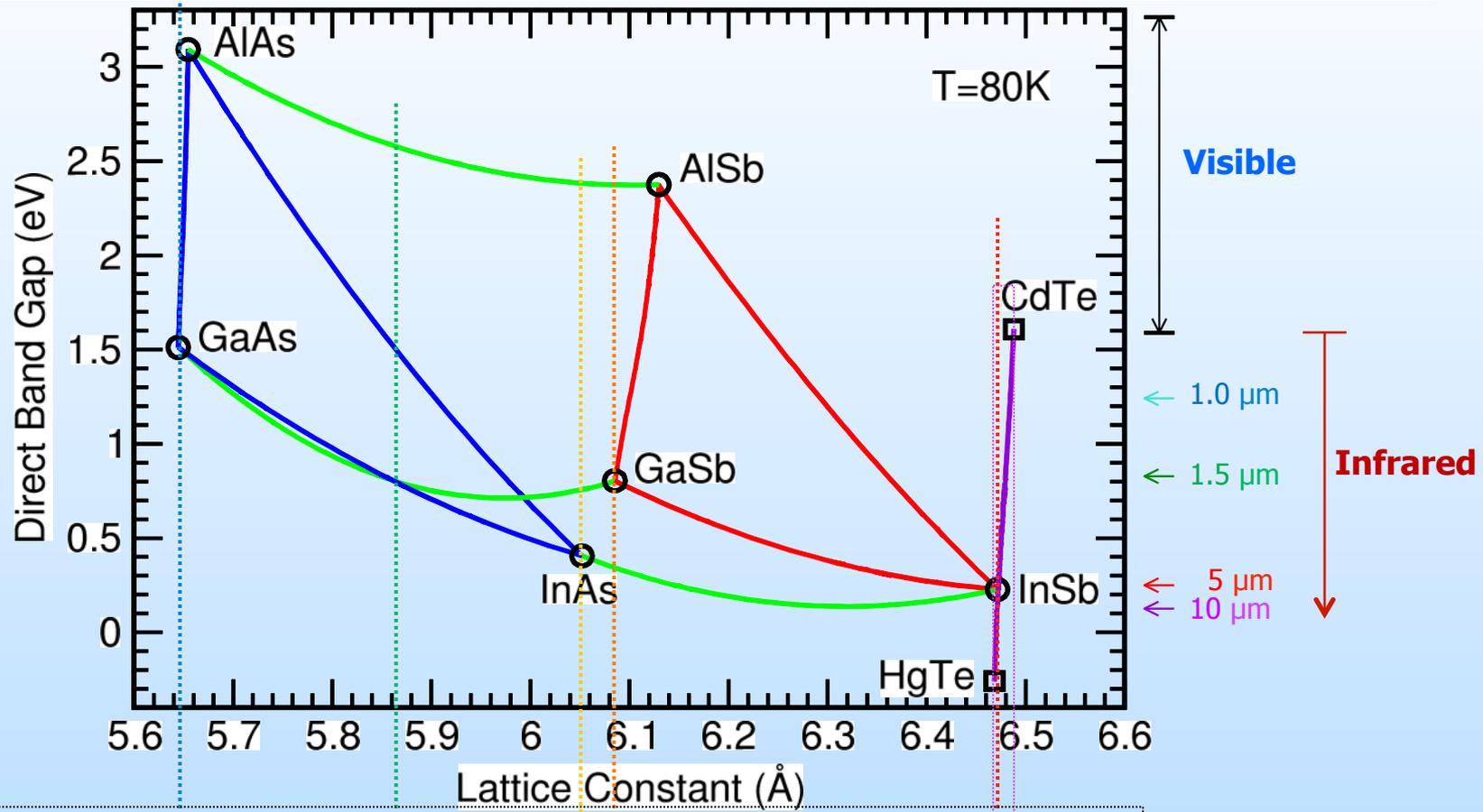
- Thermal infrared focal plane arrays (FPAs) for a variety of Earth Science related applications
 - Geology, ocean and ice changes, de-forestation, forest fires, soil moisture and plant health, weather, gas detection, pollution monitoring, ...
- Infrared band of interests
 - 3 – 5 μ m MWIR atmospheric transmission window
 - 8 – 14 μ m LWIR atmospheric transmission window
 - Outside transmission windows, e.g., $\lambda_{\text{cutoff}} \sim 15.4 \mu$ m for atmospheric sounding
- Focal plane arrays needed for
 - Imaging
 - Spectral imaging (more demanding)
- Desired infrared FPA properties
 - Customizable cutoff wavelength
 - High operability, spatial uniformity, temporal stability, scalability, and affordability
 - Low dark current and high QE
 - Higher operating temperature, less demanding cooler
 - Reduced mass, volume, power

Traditional Bulk Infrared Material Cutoff Wavelength Coverage



- MCT is the most successful infrared material to date
 - Adjustable band gap covering NIR to VLWIR. Long τ_{SRH} .
 - Soft and brittle. Requires expert handling in growth, fabrication, storage.
 - Longer λ_{cutoff} , high Hg fraction, progressively more challenging
- FPAs based on (near) lattice-matched bulk III-V semiconductors are highly successful in a few cases
 - SWIR InGaAs on InP performs at near theoretical limit
 - Single color, limited cutoff wavelength adjustability
 - InSb dominates MWIR market, despite lower operating temperature
 - Fixed cutoff wavelength, single color
 - Lacking the continuous cutoff wavelength adjustability of MCT

Semiconductor IR Material on Available Substrates



- MCT grown on **CZT** (CdZnTe) substrate covers full range of infrared
- $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ grown on **InP** substrate has $\sim 1.7 \mu\text{m}$ cutoff wavelength (covers SWIR)
- InSb grown on **InSb** substrate has $5.2 \mu\text{m}$ cutoff wavelength (covers MWIR)

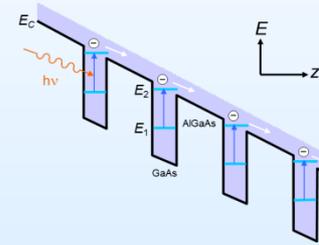
Adjustable λ_c with III-V Quantum Structures

Development at JPL Center for Infrared Photodetectors

- Quantum well infrared photodetectors (QWIPs)



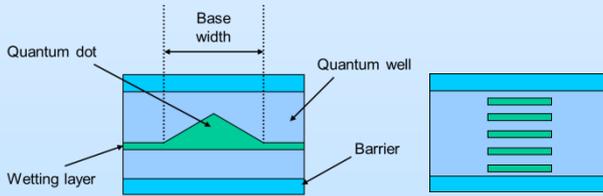
1Kx1K MW/LW Dualband QWIP



1Kx1K LWIR QWIP

- Multi-band QWIPs

- Quantum dots (QDIPs)

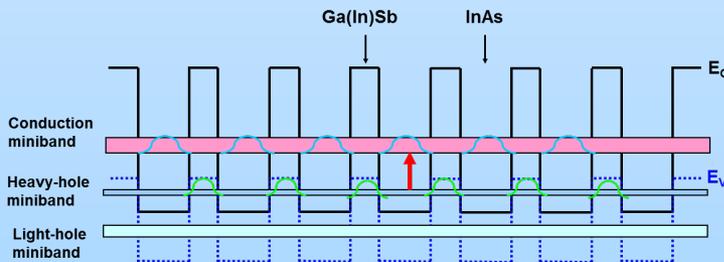


1Kx1K LWIR QDIP



640x512 LWIR QDIP

- Type-II superlattice (T2SL) Barrier IR Detector



320x256 LWIR T2SL

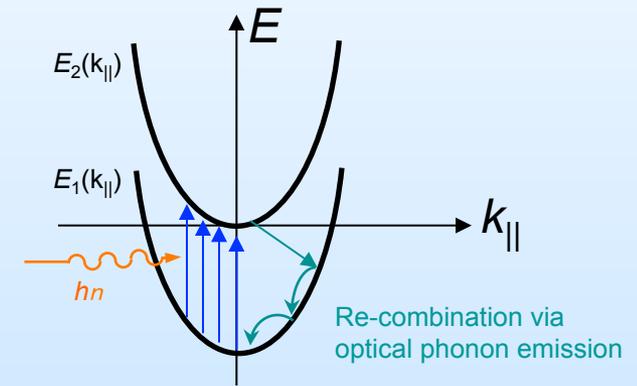
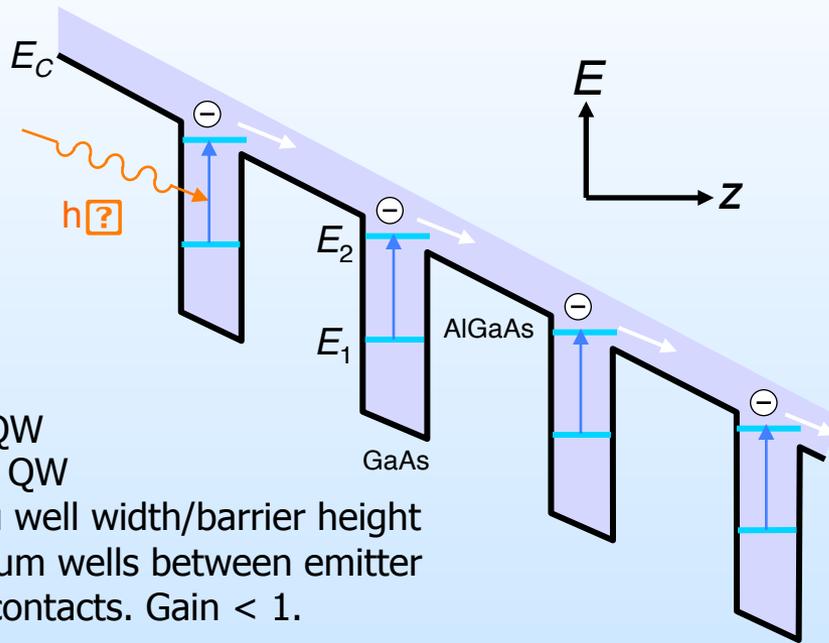


1Kx1K MWIR T2SL



1Kx1K LWIR T2SL

Quantum Well Infrared Photodetector (QWIP)

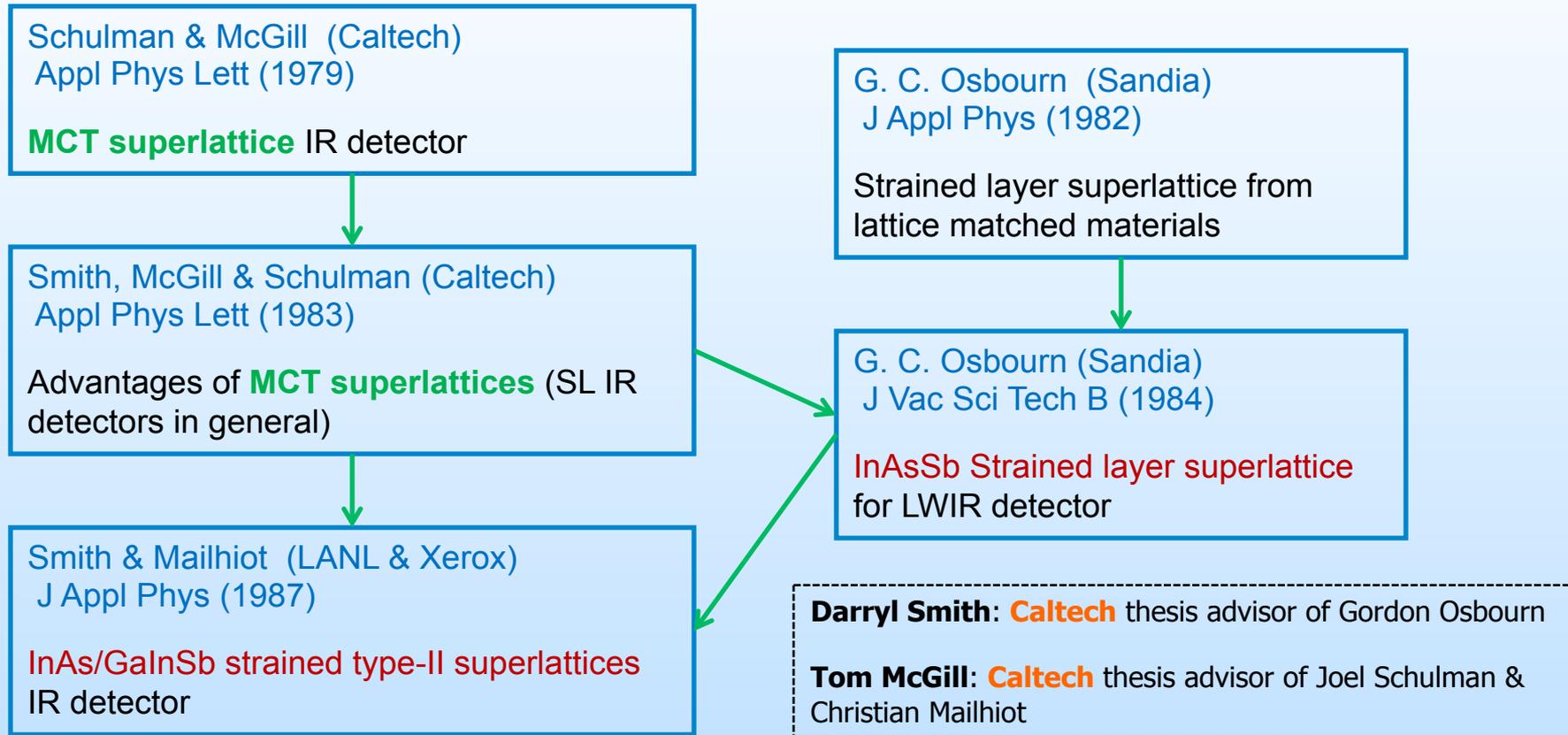


- GaAs/AlGaAs QW
 - InGaAs/InAlAs QW
 - Adjust λ_c thru well width/barrier height
 - Multiple quantum wells between emitter and collector contacts. Gain < 1.
- III-V semiconductor FPA “-ility” advantages
 - High operability, uniformity, large-format capability, producibility, affordability
 - **Temporal stability** (low 1/f noise). No need for frequent system recalibration.
 - QWIP FPAs successfully deployed in LandSat-8, HyTES
 - QWIP Challenges
 - Requires more cooling to control thermal dark current. Higher generation-recombination (G-R) rate from fast LO phonon scattering.
 - Low external QE. Needs light coupling structure for normal-incidence absorption.
 - Being addressed in R-QWIP by K. K. Choi - Resonator pixel concept.



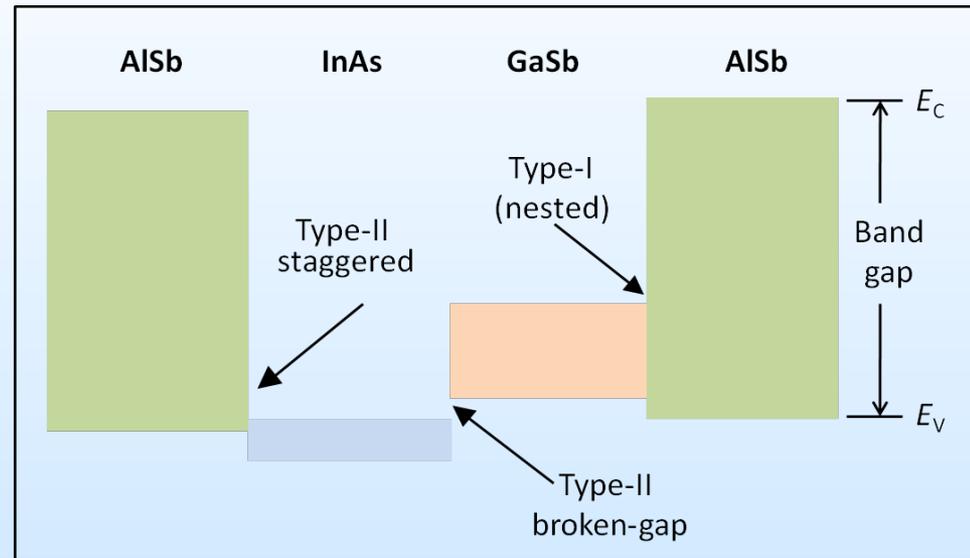
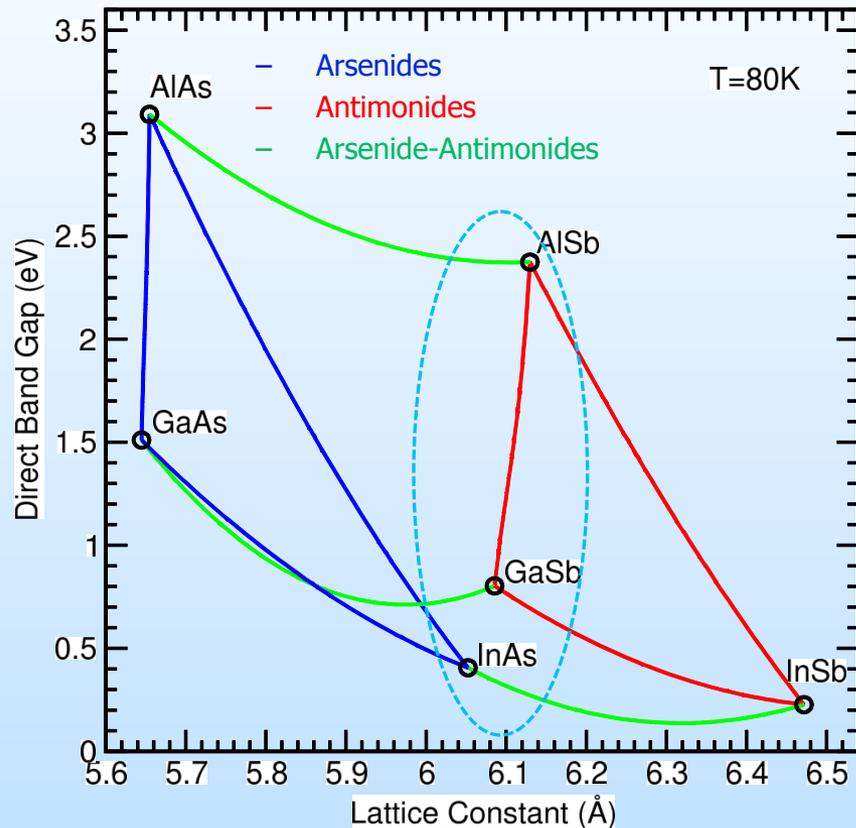
Type-II Superlattice Barrier Infrared Detector

Concept and Theoretical Foundation of Superlattice Infrared Detectors - Caltech Connection



- Originally proposed for **HgTe/CdTe superlattice**
 - Key advantages of superlattice for infrared detection pointed out in 1983 MCT SL paper
- Subsequent focus on superlattices based on the **antimonides material system**
 - Smith & Mailhiot 1987 paper considered the seminal work in T2SL infrared detectors

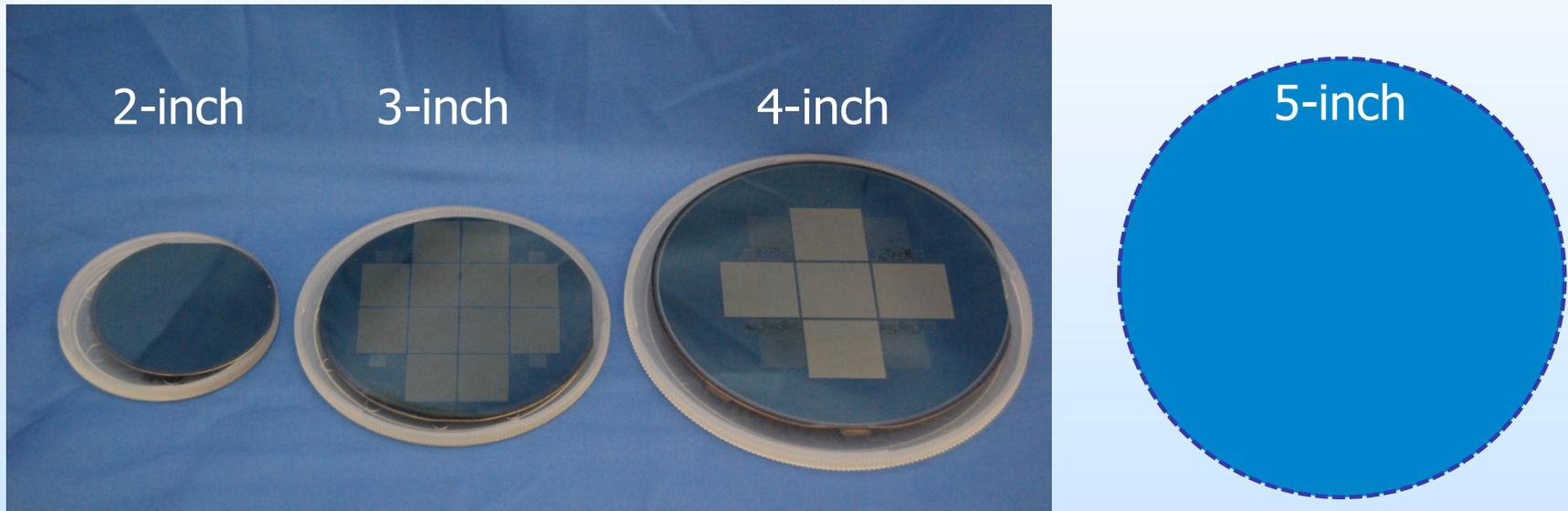
Antimonides Material System for Type-II Superlattices



- Material system includes InAs, GaSb, AlSb and their alloys
 - Nearly lattice matched (~ 6.1 Å)
- Alloys with GaAs, AlAs, and InSb adds even more flexibility
- GaSb (2", 3", 4", ...) and InAs substrates

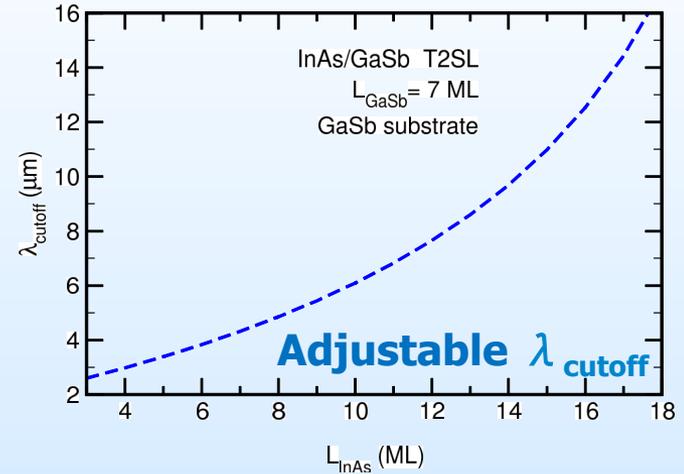
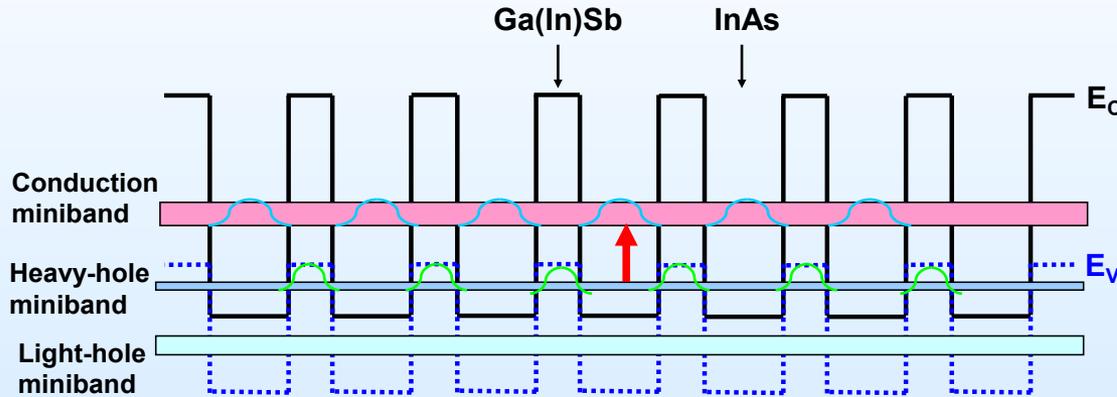
- Three types of band alignments
 - Type-I (nested, straddling)
 - Type-II staggered
 - Type-II broken gap (misaligned, Type-III)
 - Unique among common semiconductor families
 - Overlap between InAs CB and GaSb VB enables interband devices
- Tremendous flexibility in artificially designed materials / device structures

GaSb Substrate Development



- GaSb substrate available commercially in 2, 3, and 4-inch formats
 - Cost: <\$1,000 for a 3-inch substrate
 - US and UK suppliers
- Detector results demonstrated on 5 and 6-inch substrates
- Low defect density

Antimonide Type-II Superlattices

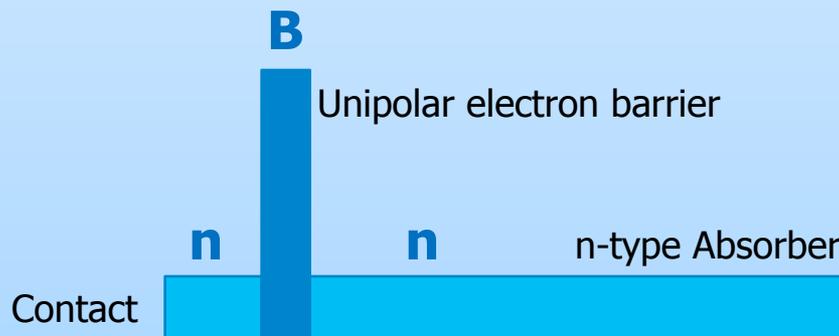


- Band gap can be made smaller than constituent bulk semiconductors
- Continuously adjustable band gap / λ_{cutoff} by varying layer widths
 - Covering SWIR, MWIR, LWIR, and VLWIR
- Sufficiently large absorption coefficient to achieve ample QE
- Dark current reduction in superlattice
 - Can be engineered for Auger suppression
 - Less susceptible to tunneling reduction
- III-V semiconductor **challenges**
 - Generation-recombination (G-R) dark current due to SRH processes
 - Surface leakage dark current without good passivation

Review Book Chapter:
"Type-II Superlattice Infrared Detectors",
D. Z. Ting, A. Soibel, L. Höglund, J. Nguyen, C. J. Hill, A. Khoshakhlagh, and S. D. Gunapala, Semiconductors and Semimetals 84, pp.1-57 (2011).

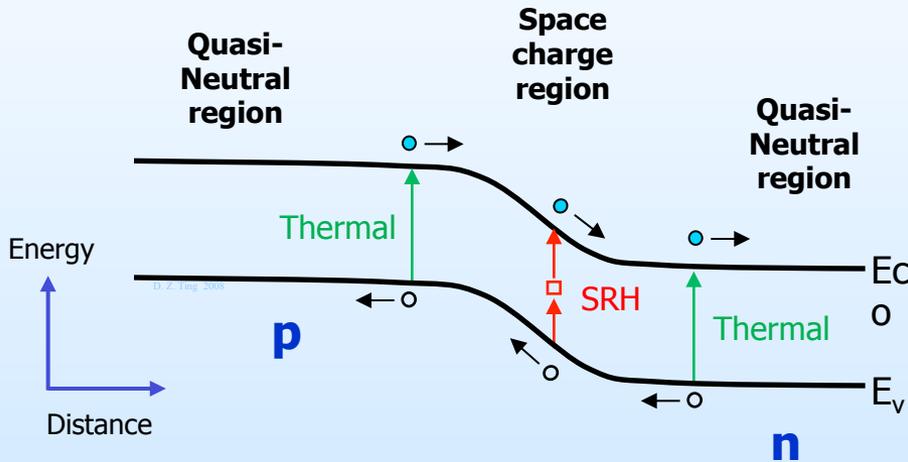
Unipolar Barrier Detector Architecture: Addressing III-V Challenges

- Maimon & Wicks “**nBn** detector, an infrared detector with reduced dark current and higher operating temperature”, *Appl Phys Lett.* (2006)
 - 240 citations on Web of Science as of June 2017
 - Arguably the most influential paper in infrared detectors in the past decade
 - The nBn and, in general, unipolar barrier infrared detectors (XBn, pBp, DH, CBIRD, ...) have been implemented in a wide variety of materials systems by research groups world-wide.
- The **unipolar barrier in nBn** blocks electrons but not holes
 - Leads to G-R and surface leakage dark current suppression

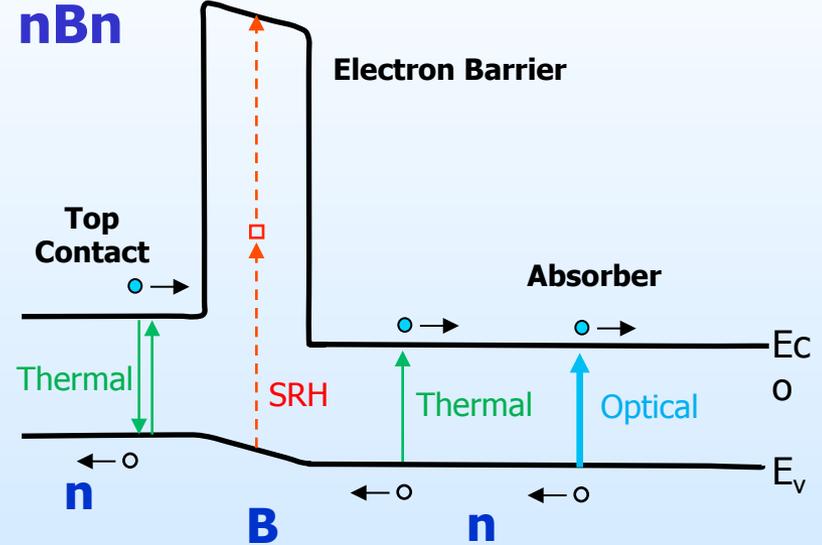


G-R Dark Current Suppression in nBn

p-n diode

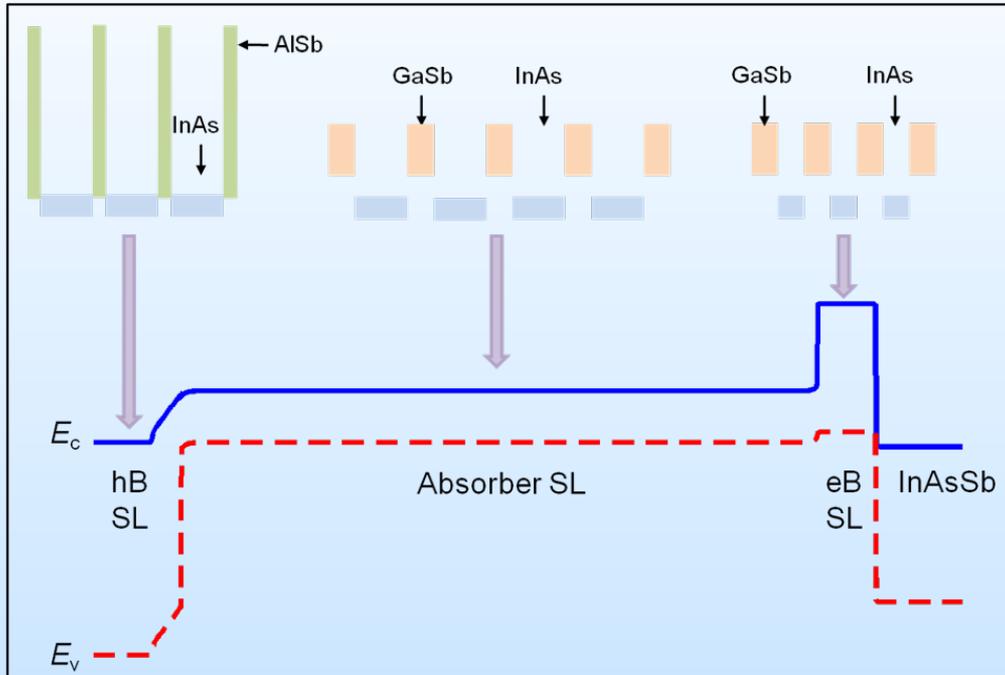


nBn



- Conventional p-n diode
 - Defects in the band gap leads to SRH processes and G-R dark current in depletion region
 - In many cases (e.g., InAs), surface of p-type layer inverts to n-type, leading to surface leakage current path
- The nBn
 - SRH processes are drastically reduced in wide-band-gap barrier region
 - Suppresses G-R dark current
 - Photocurrent flows un-impeded
 - Barrier also blocks electron surface leakage current
 - Resulting in higher operating temperature / sensitivity

Example of T2SL based Unipolar Barrier Detector: Complementary Barrier Infrared Detector (CBIRD)

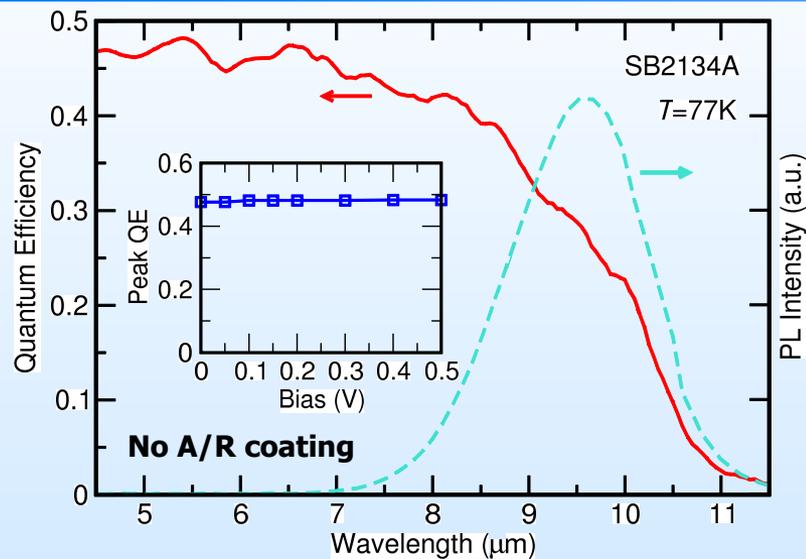


- Complementary Barrier Infrared Detector (CBIRD)
- p-type LWIR superlattice absorber
- **unipolar hole barrier** (hB)
 - widely adopted
- **unipolar electron barrier** (eB)
- Both barriers are superlattice-based

- Electron and hole barrier functions
 - Careful control of doping profile and placement of electrical (N-P) junction inside **hB** suppresses G-R dark current without disrupting the **extraction** of minority carriers
 - **eB** suppresses minority carrier injection (**exclusion**)
 - **eB** serves as a BSF layer; also suppresses electron surface leakage

Ting et al., *Appl. Phys. Lett.* **95**, 023508 (2009); **102**, 121109 (2013)

CBIRD Device Characteristics

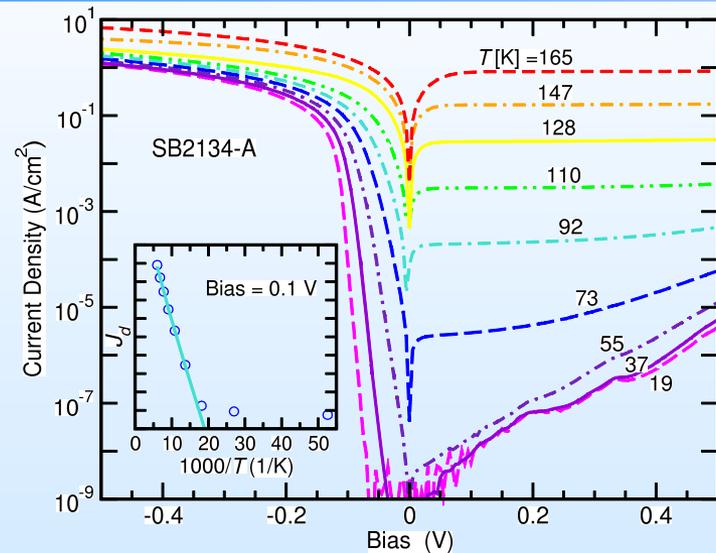


Ting et al., *Appl. Phys. Lett.* **102**, 121109 (2013)

- Discrete 200 μm × 200 μm devices
- 9.8 mm cutoff (50% peak QE)
- QE=40% (λ = 8.5 μm, no AR coating)
- Zero-bias turn-on
- $J_d(0.1V, 77K) = 0.8 \times 10^{-5} \text{ A/cm}^2$
- Near-diffusion-limited dark current behavior to below 77K

Additional studies:

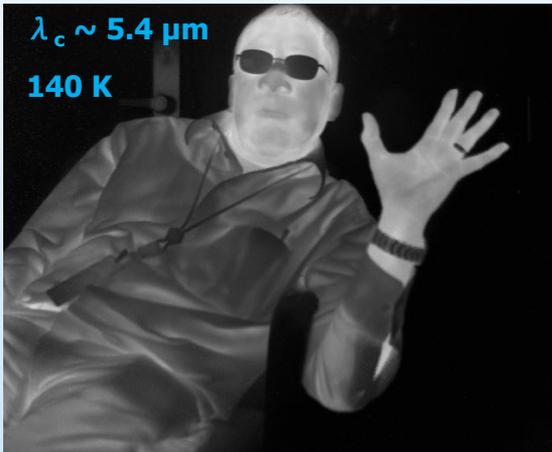
- Gain and noise: Soibel et al., *Appl. Phys. Lett.* **96**, 111102 (2010)
- Proton radiation effect: Soibel et al., *Appl. Phys. Lett.* **107**, 261102 (2015)



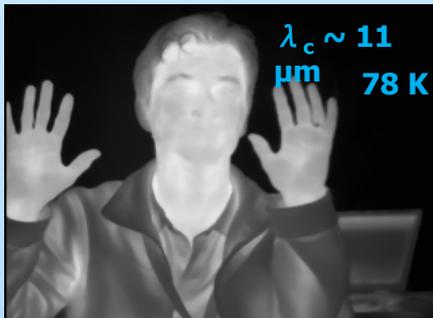
ISC 0903 DI, 320x256, 30 mm pitch
NEDT – 18.6 mK (f/2, 300K)
[Rafol et al., *JQE* **48**, 878 (2012)]

JPL T2SL Barrier Infrared Detector (BIRD) FPAs

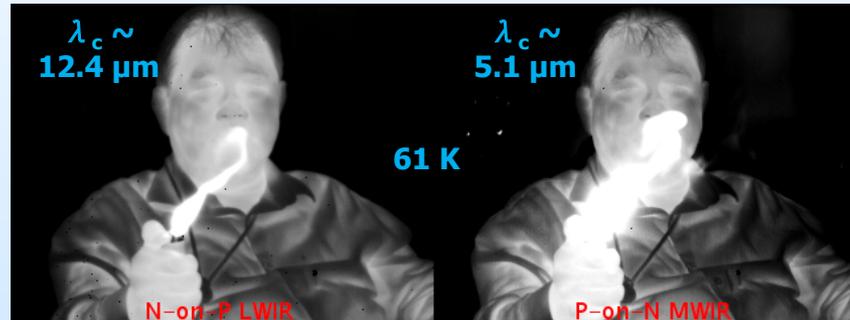
- Successfully implemented FPAs with a variety of λ_{cutoff} and formats
- High operability/uniformity routinely achieved, MWIR to VLWIR.



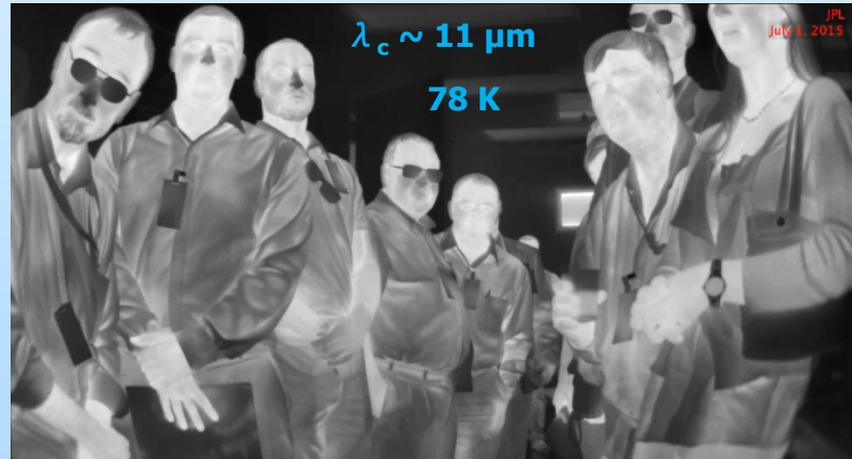
99.1% operability (640 x 512)



99.8% operability (320 x 256)



99.94% / 99.95% operability (320 x 256 switchable)



99.4% operability (1280 x 720 format)

Ting et al., *Proc SPIE* **10177**, 101770N (2017)

T2SL BIRD FPA Development for Earth Science Applications

- CubeSat Infrared Atmospheric Sounder (CIRAS)
 - High Operating Temperature (HOT) BIRD MWIR ($\lambda_{\text{cutoff}} \sim 5.3 \mu\text{m}$) FPA
- Hyperspectral Thermal Emission Spectrometer (HyTES)
 - LWIR ($\lambda_{\text{cutoff}} \sim 12 \mu\text{m}$) BIRD FPA to replace existing QWIP FPA
 - Higher QE, lower dark current, higher operating temperature
 - Retaining uniformity, operability, temporal stability ...
- SLI-T: Long Wavelength Infrared FPA for Land Imaging
 - VLWIR ($\lambda_{\text{cutoff}} \sim 13 \mu\text{m}$) BIRD FPA
 - Goal: Significantly higher operating temperature than QWIP FPA
 - Plans for demonstrating a small sensor core as well as a very large format FPAs in collaboration with industry partner



Summary

- Recent advances in III-V semiconductor IR detectors
 - Type-II superlattice (and bulk alloy) provides continuously adjustable cutoff wavelength from SWIR to VLWIR
 - Unipolar barrier device architecture enhances detector performance
- MWIR to VLWIR type-II superlattice barrier infrared detector (BIRD) FPAs routinely achieve high operability and uniformity
- Meeting a variety of Earth Science infrared FPA needs